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To the Director of the U.S. Patent and Trademark Office

103311252

and documents or the new address(es) below.

1. Name of conveying party(ies)

Ching-Tai CHENG
Nien-Tien CHENG

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) September 11, 2006

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: Foxconn Technology Co., Ltd

Internal Address:

Street Address: 3-2, Chung Shan Road

City: Tu-Cheng

State:

Country: Taipei Hsien, Taiwan Zip:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Jeffrey T. Knapp

Internal Address:

Street Address: PCE Industry, Inc.
458 E. Lambert Rd.

City: Fullerton

State: CA Zip: 92835

Phone Number: (714) 626-1229

Fax Number: (714) 738-4649

Email Address: JTKNAPP@FOXCONN.COM

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card
☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers
Expiration Date

b. Deposit Account Number 50-3789

Authorized User Name Jeffrey T. Knapp

9. Signature:

Jeffrey T. Knapp
Signature

Jeffrey T. Knapp
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 3

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. Ching-Tai CHENG , residing at Tu-Cheng, Taipei, Taiwan
2. Nien-Tien CHENG , residing at Tu-Cheng, Taipei, Taiwan
3. _____ , residing at _____
4. _____ , residing at _____
5. _____ , residing at _____
6. _____ , residing at _____
7. _____ , residing at _____
8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: Foxconn Technology Co., Ltd having a principal place of business at 3-2, Chung Shan Road, Tu-Cheng, Taipei Hsien, Taiwan, ROC hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as THERMAL INTERFACE MATERIAL for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____

[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1. Ching-Tai Cheng
Ching-Tai Cheng inventor

Sep. 11, 2006
Date

Witness

2. Nien-Tien Cheng
Nien-Tien Cheng inventor

Sep. 11, 2006
Date

Witness

3. _____
inventor

Date

Witness

4. _____
inventor

Date

Witness

5. _____
inventor

Date

Witness

6. _____
inventor

Date

Witness

7. _____
inventor

Date

Witness

8. _____
inventor

Date

Witness